

Electronic Patent Application Fee Transmittal

Application Number:	10611480				
Filing Date:	01-Jul-2003				
Title of Invention:	Bond surface conditioning system for improved bondability				
First Named Inventor:	Sean Michael Malolepszy				
Filer:	Yingsheng Tung/Jackie McBride				
Attorney Docket Number:	TI-33434.1				
Filed as Large Entity					
Utility Filing Fees					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:					
Pages:					
Claims:					
Miscellaneous-Filing:					
Petition:					
Patent-Appeals-and-Interference:					
Post-Allowance-and-Post-Issuance:					
Extension-of-Time:					
Extension - 2 months with \$0 paid		1252	1	450	450

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				450